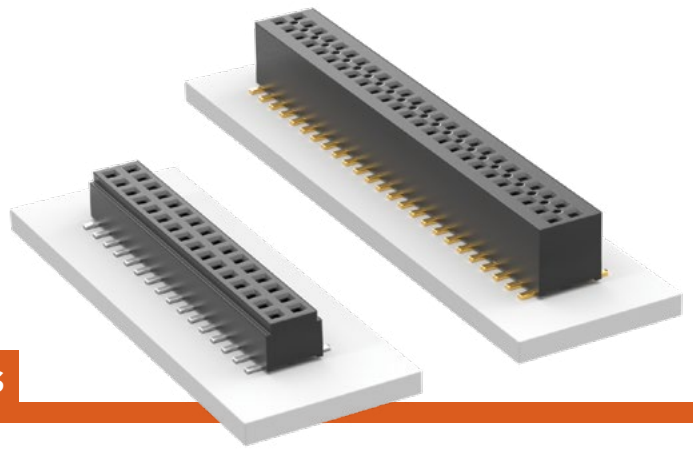


RUGGED RELIABLE MICRO SOCKETS

(1.00 mm) .0394" PITCH • CLM/MLE SERIES



CLM

Mates:
FTM, FTMH, MW

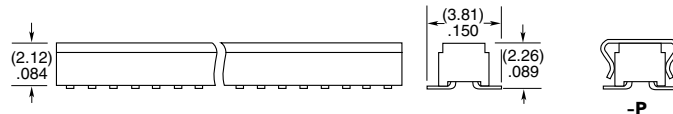
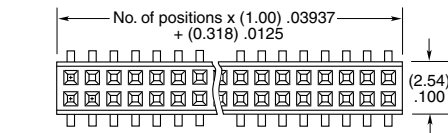
MLE

Mates:
FTM, FTMH, MW

SPECIFICATIONS

Insulator Material: Black LCP
Contact Material:
CLM: Phosphor Bronze
MLE: BeCu
Plating:
CLM: Au or Sn over
50 μ " (1.27 μ m) Ni
MLE: Au over 10 μ " (0.25 μ m) Ni
Current Rating (CLM/FTM):
3.1 A per pin
(2 pins powered)
Current Rating (MLE/FTM):
2.9 A per pin (2 pins powered)
Operating Temp Range:
-55 °C to +125 °C
Max Cycles:
CLM: 100 with 10 μ " (0.25 μ m) Au
Voltage Rating:
CLM: 270 VAC
MLE: 310 VAC
Insertion Depth:
CLM:
Top Entry = (1.40 mm) .055" min.,
Bottom Entry =
(2.41 mm) .095" min.
(Add board thickness for
correct post OAL)
MLE:
(1.63 mm) .064" to
(3.18 mm) .125" with
(0.38 mm) .015" wipe,
pass-through, or (2.44 mm) .096"
minimum for bottom entry

**TIGER
CLAW
CONTACT**



PIN/ROW	A
04-15	(3.56) .140
16-50	(7.11) .280

PROCESSING

Lead-Free Solderable:
Yes
SMT Lead Coplanarity:
(0.10 mm) .004" max (02-25)
(0.15 mm) .006" max (26-50)*
*(.004" stencil solution
may be available; contact
ipg@samtec.com)

ALSO AVAILABLE

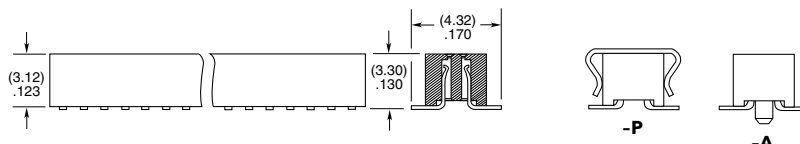
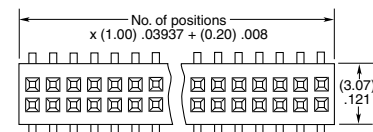
MOQ Required

Alignment pin
Other Gold plating options



Note:
Some lengths, styles and
options are non-standard,
non-returnable.

**TIGER
BEAM
CONTACT**



MLE

1

**NO. PINS
PER ROW**

01

**PLATING
OPTION**

DV

OPTIONS

02 thru 50

-G
= 10 μ "
(0.25 μ m)
Gold

-A
= Alignment Pin
(3 positions minimum)
Metal or plastic
at Samtec discretion

-K
= (4.00 mm) .1575" DIA
Polyimide film
Pick & Place Pad
(5 positions minimum)

-P
= Metal Pick & Place Pad
(5 positions minimum)

-TR
= Tape & Reel

-FR
= Full Reel Tape & Reel
(must order maximum
quantity per reel;
contact Samtec for
quantity breaks)

Mouser Electronics

Authorized Distributor

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